

## Product Summary

$V_{(BR)DSS}$	$R_{DS(on)}$ Max	$I_D$ $T_A = +25^\circ C$
40V	27m $\Omega$ @ $V_{GS} = 10V$	7.1A
	47m $\Omega$ @ $V_{GS} = 4.5V$	5.4A

## Description

This MOSFET has been designed to minimize the on-state resistance and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

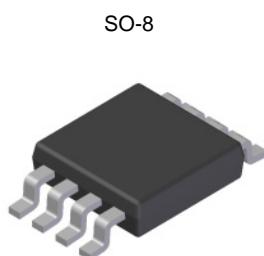
- Motor Control
- Backlighting
- DC-DC Converters
- Power Management Functions

## Features and Benefits

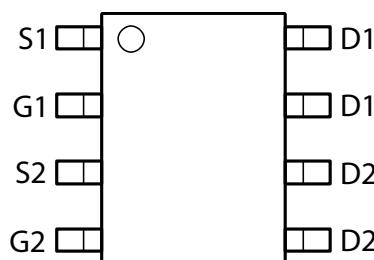
- Low on-resistance
- Fast switching speed
- **Totally Lead-Free & Fully RoHS compliant (Notes 1 & 2)**
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

## Mechanical Data

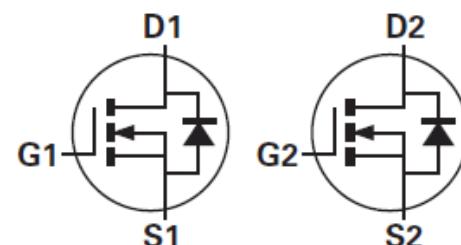
- Case: SO-8
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals Connections: See diagram below
- Terminals: Finish - Matte Tin annealed over Copper lead frame. Solderable per MIL-STD-202, Method 208 (e3)
- Weight: 0.074 grams (approximate)



Top View



Top View



Equivalent Circuit

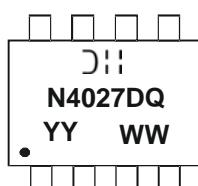
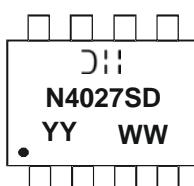
## Ordering Information (Note 4)

Part Number	Compliance	Case	Packaging
DMN4027SSD-13	Standard	SO-8	2500 / Tape & Reel
DMN4027SSDQ-13	Automotive	SO-8	2500 / Tape & Reel

## Notes:

1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
2. See [http://www.diodes.com/quality/lead\\_free.html](http://www.diodes.com/quality/lead_free.html) for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
3. Halogen and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
4. For packaging details, go to our website at <http://www.diodes.com/products/packages.html>.

## Marking Information



DII = Manufacturer's Marking

N4027SD = Product Type Marking Code for DMN4027SSD-13

N4027DQ = Product Type Marking Code for DMN4027SSDQ-13

YYWW = Date Code Marking

YY = Year (ex: 09 = 2009)

WW = Week (01-53)

**Maximum Ratings** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Drain-Source Voltage		$V_{DSS}$	40	V
Gate-Source Voltage	(Note 5)	$V_{GS}$	$\pm 20$	V
Continuous Drain Current	$V_{GS} = 10\text{V}$	$I_D$	7.1	A
			5.7	
			5.4	
Pulsed Drain Current	$V_{GS} = 10\text{V}$	$I_{DM}$	28.0	A
Continuous Source Current (Body diode)	(Notes 7)	$I_S$	3.3	A
Pulsed Source Current (Body diode)	(Notes 8)	$I_{SM}$	28.0	A

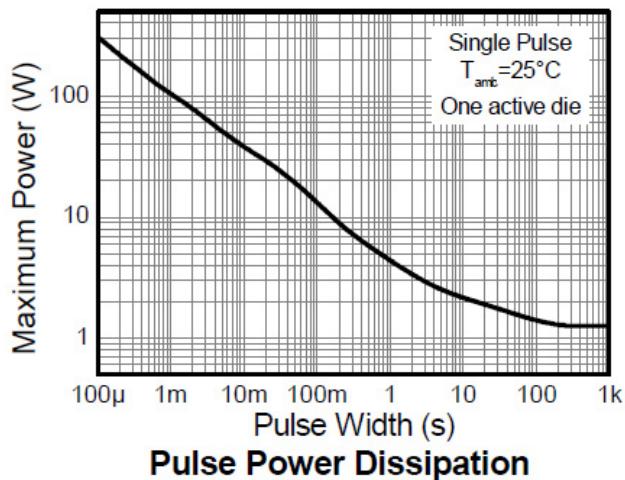
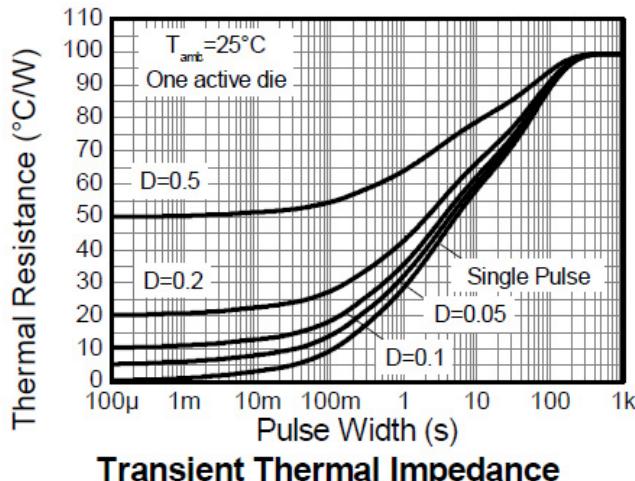
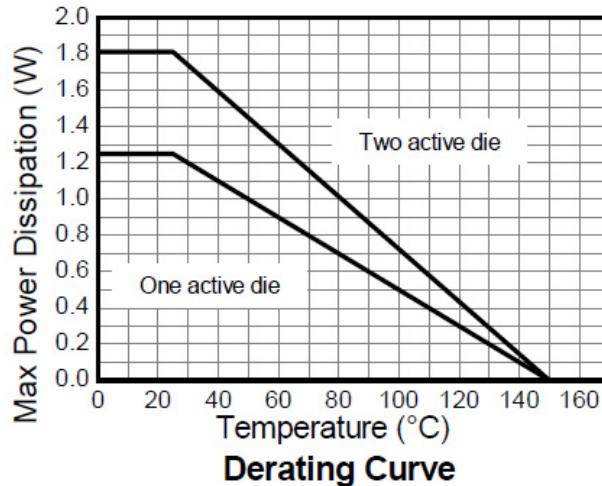
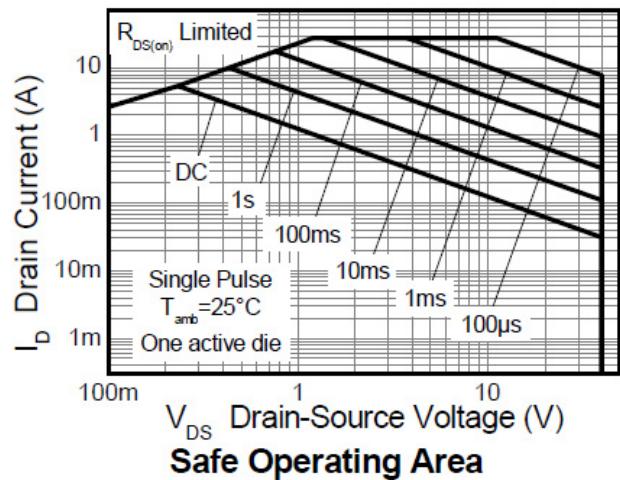
**Thermal Characteristics** (@ $T_A = +25^\circ\text{C}$ , unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Power Dissipation Linear Derating Factor	(Notes 6 & 9)	$P_D$	1.25	W mW/°C
	(Notes 6 & 10)		10.0	
	(Notes 7 & 9)		1.8	
Thermal Resistance, Junction to Ambient	(Notes 6 & 9)	$R_{\theta JA}$	14.3	°C/W
	(Notes 6 & 10)		2.14	
	(Notes 7 & 9)		58	
Thermal Resistance, Junction to Lead	(Notes 9 & 11)	$R_{\theta JL}$	53	
Operating and Storage Temperature Range		$T_J, T_{STG}$	-55 to +150	°C

Notes:

- 5. AEC-Q101  $V_{GS}$  maximum is  $\pm 16\text{V}$ .
- 6. For a device surface mounted on 25mm x 25mm x 1.6mm FR4 PCB with high coverage of single sided 1oz copper, in still air conditions; the device is measured when operating in a steady-state condition.
- 7. Same as note (3), except the device is measured at  $t \leq 10$  sec.
- 8. Same as note (3), except the device is pulsed with  $D = 0.02$  and pulse width 300 $\mu\text{s}$ . The pulse current is limited by the maximum junction temperature.
- 9. For a dual device with one active die.
- 10. For a device with two active die running at equal power.
- 11. Thermal resistance from junction to solder-point (at the end of the drain lead).

## Thermal Characteristics



## Electrical Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

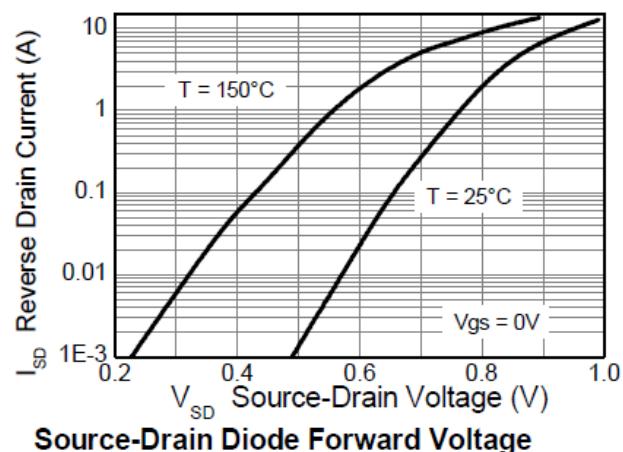
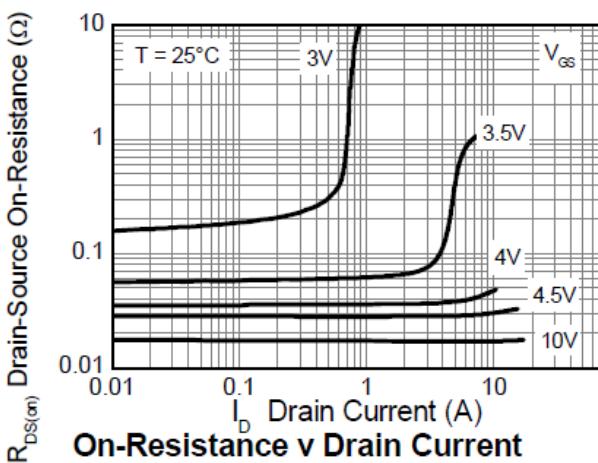
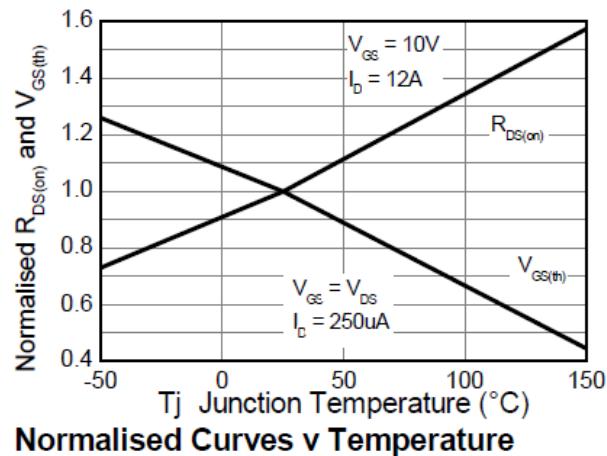
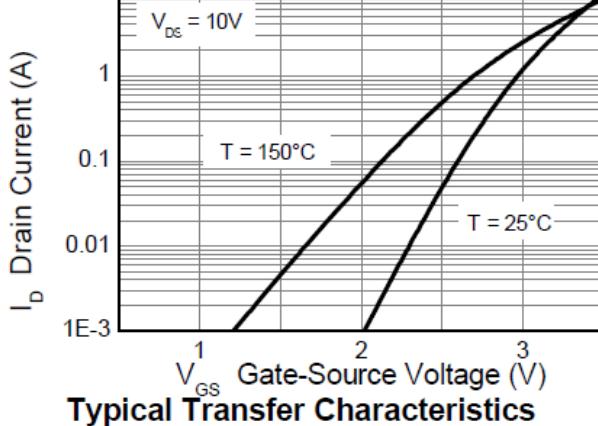
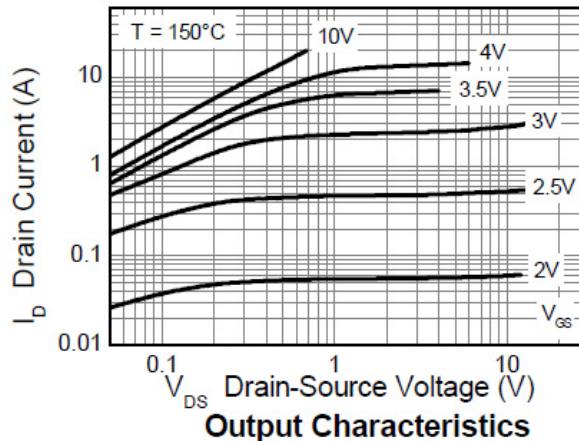
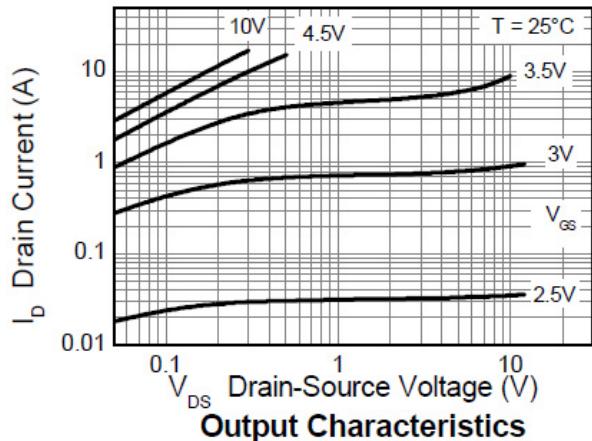
Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
<b>OFF CHARACTERISTICS</b>						
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	40	—	—	V	I <sub>D</sub> = 250µA, V <sub>GS</sub> = 0V
Zero Gate Voltage Drain Current	I <sub>DSS</sub>	—	—	0.5	µA	V <sub>DS</sub> = 40V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	—	—	±100	nA	V <sub>GS</sub> = ±20V, V <sub>DS</sub> = 0V
<b>ON CHARACTERISTICS</b>						
Gate Threshold Voltage	V <sub>GS(th)</sub>	1.0	—	3.0	V	I <sub>D</sub> = 250µA, V <sub>DS</sub> = V <sub>GS</sub>
Static Drain-Source On-Resistance (Note 12)	R <sub>DS(ON)</sub>	—	0.017	0.027	Ω	V <sub>GS</sub> = 10V, I <sub>D</sub> = 7A
			0.031	0.047		V <sub>GS</sub> = 4.5V, I <sub>D</sub> = 6A
Forward Transconductance (Notes 12 & 13)	g <sub>fs</sub>	—	22.8	—	S	V <sub>DS</sub> = 15V, I <sub>D</sub> = 7A
Diode Forward Voltage (Note 12)	V <sub>SD</sub>	—	0.86	1.1	V	I <sub>S</sub> = 7A, V <sub>GS</sub> = 0V
Reverse recovery time (Note 13)	t <sub>rr</sub>	—	12.1	—	ns	I <sub>S</sub> = 2.1A, di/dt = 100A/µs
Reverse recovery charge (Note 13)	Q <sub>rr</sub>	—	5.1	—	nC	
<b>DYNAMIC CHARACTERISTICS (Note 13)</b>						
Input Capacitance	C <sub>iss</sub>	—	604	—	pF	V <sub>DS</sub> = 20V, V <sub>GS</sub> = 0V f = 1MHz
Output Capacitance	C <sub>oss</sub>	—	106	—	pF	
Reverse Transfer Capacitance	C <sub>rss</sub>	—	59.6	—	pF	
Total Gate Charge (Note 14)	Q <sub>g</sub>	—	6.3	—	nC	V <sub>GS</sub> = 4.5V V <sub>GS</sub> = 10V I <sub>D</sub> = 7A
Total Gate Charge Note 14)	Q <sub>g</sub>	—	12.9	—	nC	
Gate-Source Charge Note 14)	Q <sub>gs</sub>	—	2.4	—	nC	
Gate-Drain Charge Note 14)	Q <sub>gd</sub>	—	3.3	—	nC	V <sub>DD</sub> = 20V, V <sub>GS</sub> = 10V I <sub>D</sub> = 1A, R <sub>G</sub> ≥ 6.0Ω
Turn-On Delay Time Note 14)	t <sub>D(on)</sub>	—	3.1	—	ns	
Turn-On Rise Time Note 14)	t <sub>r</sub>	—	3.1	—	ns	
Turn-Off Delay Time (Note 14)	t <sub>D(off)</sub>	—	15.4	—	ns	
Turn-Off Fall Time Note 14)	t <sub>f</sub>	—	7.5	—	ns	

Notes: 12. Measured under pulsed conditions. Pulse width ≤ 300µs; duty cycle ≤ 2%.

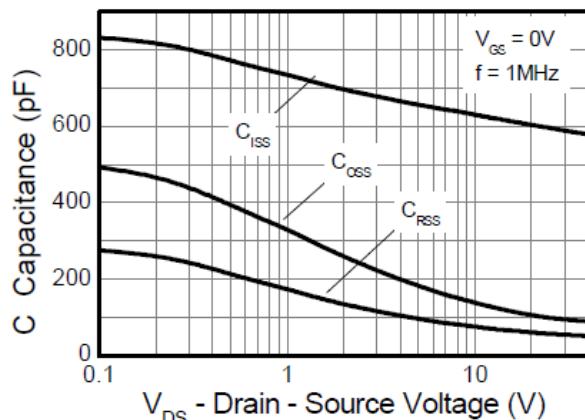
13. For design aid only, not subject to production testing.

14. Switching characteristics are independent of operating junction temperatures.

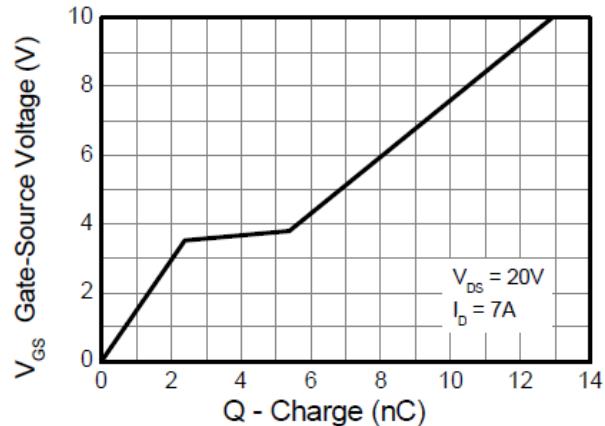
## Typical Characteristics



## Typical Characteristics (cont.)

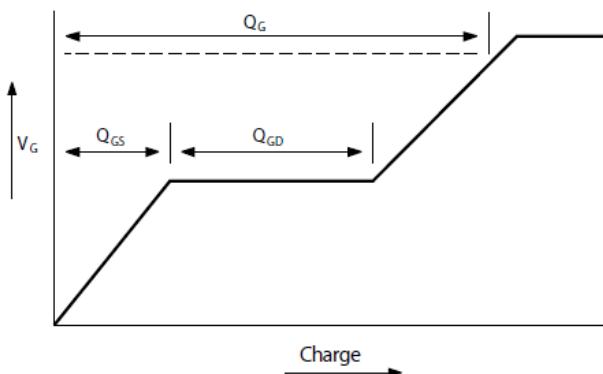


Capacitance v Drain-Source Voltage

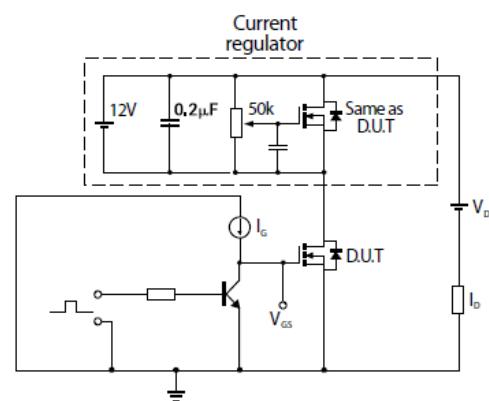


Gate-Source Voltage v Gate Charge

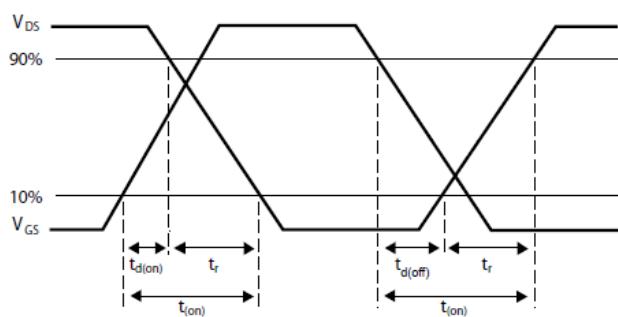
## Test Circuits



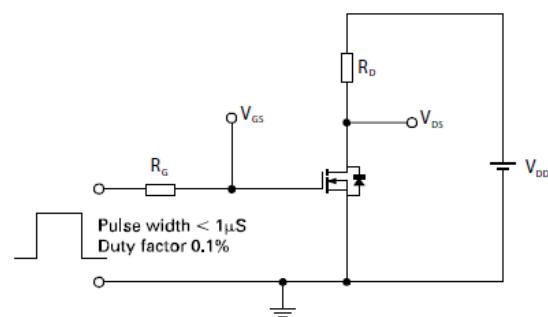
Basic gate charge waveform



Gate charge test circuit



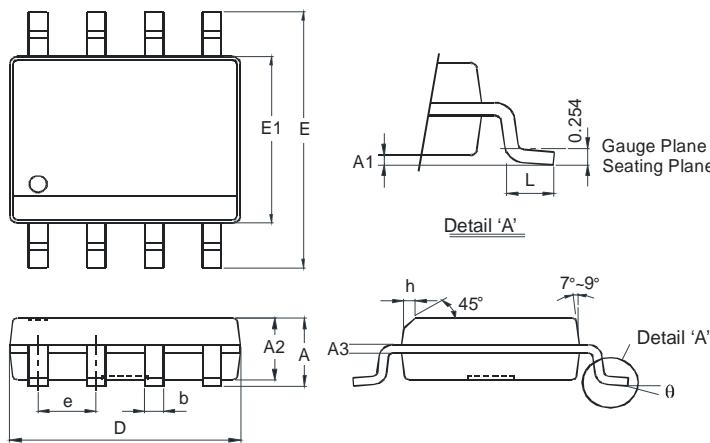
Switching time waveforms



Switching time test circuit

## Package Outline Dimensions

Please see AP02002 at <http://www.diodes.com/datasheets/ap02002.pdf> for latest version.

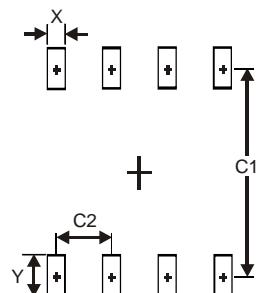


SO-8		
Dim	Min	Max
<b>A</b>	-	1.75
<b>A1</b>	0.10	0.20
<b>A2</b>	1.30	1.50
<b>A3</b>	0.15	0.25
<b>b</b>	0.3	0.5
<b>D</b>	4.85	4.95
<b>E</b>	5.90	6.10
<b>E1</b>	3.85	3.95
<b>e</b>	1.27 Typ	
<b>h</b>	-	0.35
<b>L</b>	0.62	0.82
<b>θ</b>	0°	8°

All Dimensions in mm

## Suggested Pad Layout

Please see AP02001 at <http://www.diodes.com/datasheets/ap02001.pdf> for the latest version.



Dimensions	Value (in mm)
<b>X</b>	0.60
<b>Y</b>	1.55
<b>C1</b>	5.4
<b>C2</b>	1.27

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